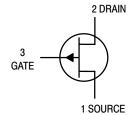


# JFET Amplifiers P-Channel — Depletion



# 2N5460 2N5461 2N5462

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit	
Drain-Gate Voltage	V <sub>DG</sub>	40	Vdc	
Reverse Gate-Source Voltage	VGSR	40	Vdc	
Forward Gate Current	I <sub>G(f)</sub>	10	mAdc	
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	PD	350 2.8	mW mW/°C	
Junction Temperature Range	TJ	-65 to +135	°C	
Storage Channel Temperature Range	T <sub>stg</sub>	-65 to +150	°C	



### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Gate–Source Breakdown Voltage (I <sub>G</sub> = 10 μAdc, V <sub>DS</sub> = 0)	2N5460, 2N5461, 2N5462	V(BR)GSS	40	_	_	Vdc
Gate Reverse Current (VGS = 20 Vdc, VDS = 0) (VGS = 30 Vdc, VDS = 0) (VGS = 20 Vdc, VDS = 0, TA = 100°C) (VGS = 30 Vdc, VDS = 0, TA = 100°C)	2N5460, 2N5461, 2N5462 2N5460, 2N5461, 2N5462	IGSS	_		5.0	nAdc μAdc
Gate–Source Cutoff Voltage (V <sub>DS</sub> = 15 Vdc, I <sub>D</sub> = 1.0 μAdc)	2N5460 2N5461 2N5462	VGS(off)	0.75 1.0 1.8	 _ _	6.0 7.5 9.0	Vdc
$\label{eq:Gate-Source Voltage} \begin{tabular}{ll} Gate-Source Voltage \\ (V_{DS} = 15 \mbox{ Vdc, } I_{D} = 0.1 \mbox{ mAdc)} \\ (V_{DS} = 15 \mbox{ Vdc, } I_{D} = 0.2 \mbox{ mAdc)} \\ (V_{DS} = 15 \mbox{ Vdc, } I_{D} = 0.4 \mbox{ mAdc)} \\ \end{tabular}$	2N5460 2N5461 2N5462	VGS	0.5 0.8 1.5	_ _ _	4.0 4.5 6.0	Vdc

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit	
ON CHARACTERISTICS							
Zero-Gate-Voltage Drain Current (V <sub>DS</sub> = 15 Vdc, V <sub>GS</sub> = 0, f = 1.0 kHz)	2N5460 2N5461 2N5462	IDSS	-1.0 -2.0 -4.0		-5.0 -9.0 -16	mAdc	
SMALL-SIGNAL CHARACTERISTICS							
Forward Transfer Admittance (V <sub>DS</sub> = 15 Vdc, V <sub>GS</sub> = 0, f = 1.0 kHz)	2N5460 2N5461 2N5462	lyfs	1000 1500 2000	_ 	4000 5000 6000	μmhos	
Output Admittance (VDS = 15 Vdc, VGS = 0, f = 1.0 kHz)		y <sub>os</sub>	_	_	75	μmhos	
Input Capacitance (V <sub>DS</sub> = 15 Vdc, V <sub>GS</sub> = 0, f = 1.0 MHz)		C <sub>iss</sub>	_	5.0	7.0	pF	
Reverse Transfer Capacitance (V <sub>DS</sub> = 15 Vdc, V <sub>GS</sub> = 0, f = 1.0 MHz)		C <sub>rss</sub>	_	1.0	2.0	pF	
FUNCTIONAL CHARACTERISTICS							
Equivalent Short–Circuit Input Noise Voltage (V <sub>DS</sub> = 15 Vdc, V <sub>GS</sub> = 0, f = 100 Hz, BW = 1.0 Hz)		e <sub>n</sub>	_	60	115	nV/√Hz	

# DRAIN CURRENT versus GATE SOURCE VOLTAGE

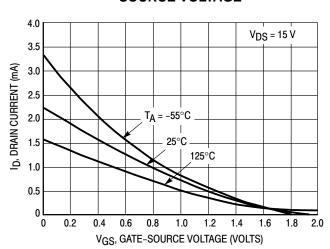


Figure 1.  $V_{GS(off)} = 2.0 \text{ Volts}$ 

# FORWARD TRANSFER ADMITTANCE versus DRAIN CURRENT

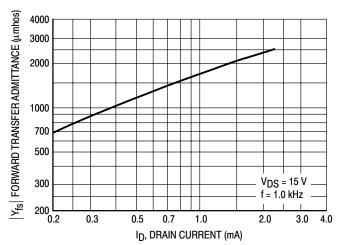


Figure 4. V<sub>GS(off)</sub> = 2.0 Volts

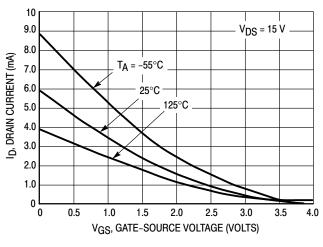


Figure 2. VGS(off) = 4.0 Volts

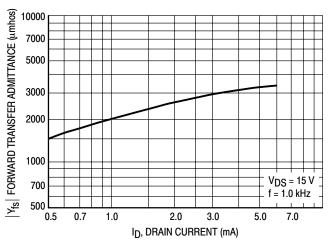


Figure 5. VGS(off) = 4.0 Volts

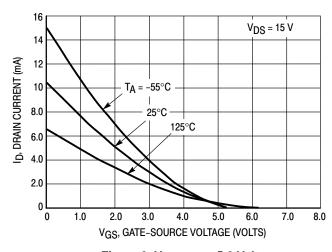


Figure 3.  $V_{GS(off)} = 5.0 \text{ Volts}$ 

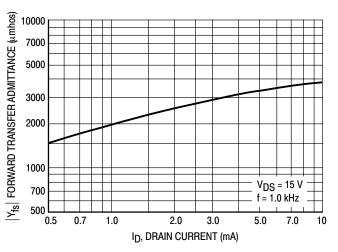


Figure 6.  $V_{GS(off)} = 5.0 \text{ Volts}$ 

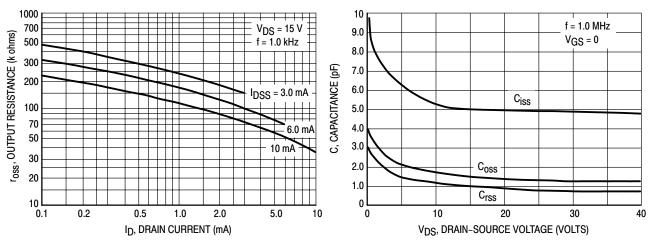


Figure 7. Output Resistance versus Drain Current

Figure 8. Capacitance versus Drain-Source Voltage

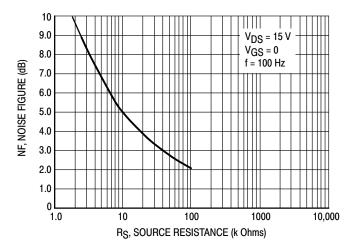
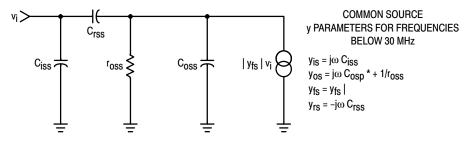


Figure 9. Noise Figure versus Source Resistance



\*Cosp is Coss in parallel with Series Combination of Ciss and Crss.

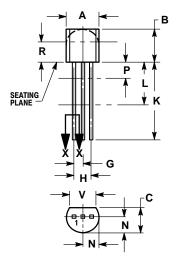
#### NOTE:

 Graphical data is presented for dc conditions. Tabular data is given for pulsed conditions (Pulse Width = 630 ms, Duty Cycle = 10%).

Figure 10. Equivalent Low Frequency Circuit

### **PACKAGE DIMENSIONS**

TO-92 (TO-226AA) CASE 29-11 ISSUE AL





STYLE 7: PIN 1. SOURCE 2. DRAIN 3. GATE

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
  4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	ETERS		
DIM	MIN	MAX	MIN	MAX		
Α	0.175	0.205	4.45	5.20		
В	0.170	0.210	4.32	5.33		
С	0.125	0.165	3.18	4.19		
D	0.016	0.021	0.407	0.533		
G	0.045	0.055	1.15	1.39		
Н	0.095	0.105	2.42	2.66		
J	0.015	0.020	0.39	0.50		
K	0.500	-	12.70			
L	0.250		6.35			
N	0.080	0.105	2.04	2.66		
P		0.100		2.54		
R	0.115		2.93			
V	0.135		3.43			





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